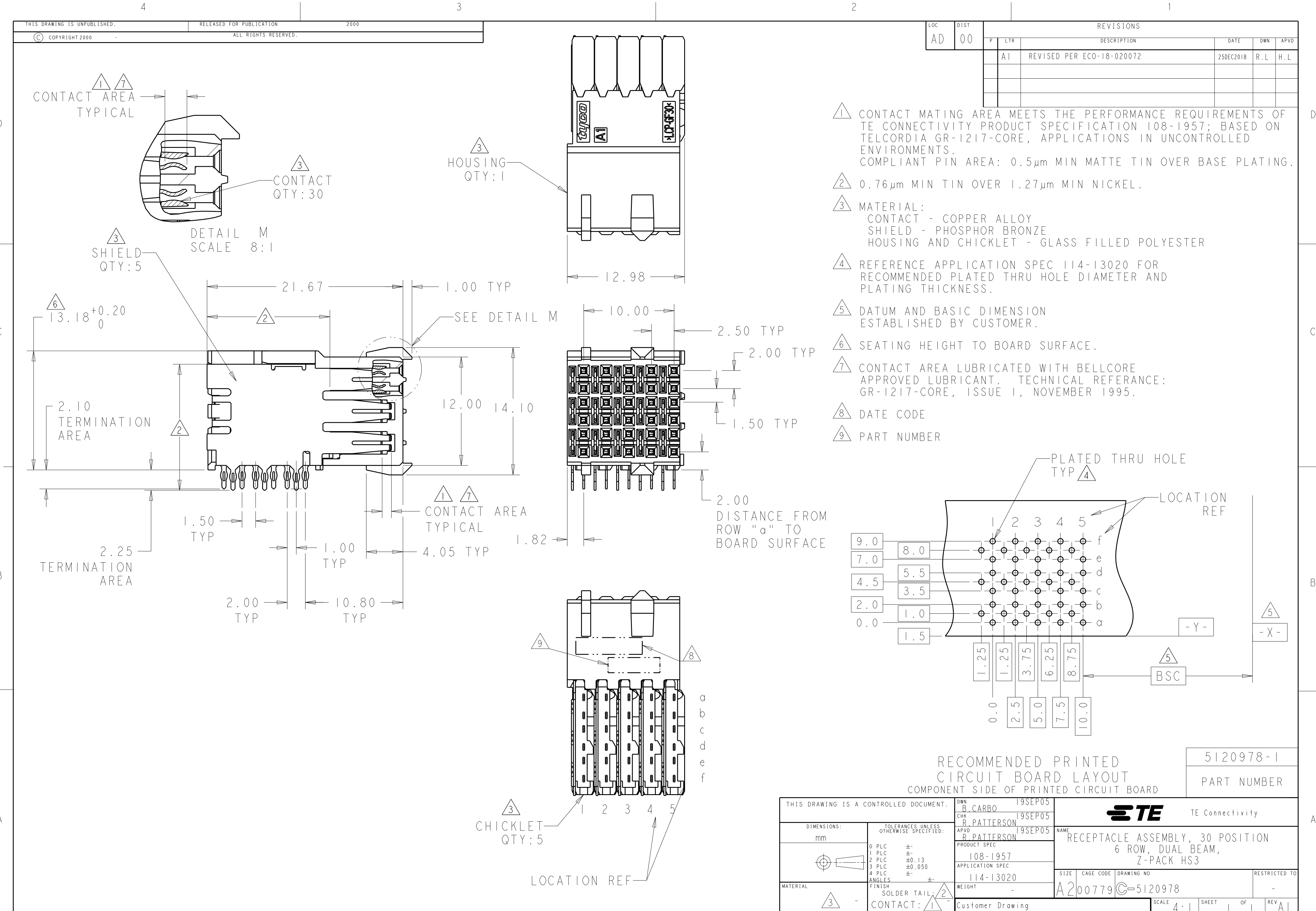




LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
AD	00		A1	REVISED PER ECO-18-020072	25DEC2018	R.L	H.L

- 1 CONTACT MATING AREA MEETS THE PERFORMANCE REQUIREMENTS OF TE CONNECTIVITY PRODUCT SPECIFICATION 108-1957; BASED ON TELCORDIA GR-1217-CORE, APPLICATIONS IN UNCONTROLLED ENVIRONMENTS. COMPLIANT PIN AREA: 0.5µm MIN MATTE TIN OVER BASE PLATING.
- 2 0.76µm MIN TIN OVER 1.27µm MIN NICKEL.
- 3 MATERIAL:
CONTACT - COPPER ALLOY
SHIELD - PHOSPHOR BRONZE
HOUSING AND CHICKLET - GLASS FILLED POLYESTER
- 4 REFERENCE APPLICATION SPEC 114-13020 FOR RECOMMENDED PLATED THRU HOLE DIAMETER AND PLATING THICKNESS.
- 5 DATUM AND BASIC DIMENSION ESTABLISHED BY CUSTOMER.
- 6 SEATING HEIGHT TO BOARD SURFACE.
- 7 CONTACT AREA LUBRICATED WITH BELLCORE APPROVED LUBRICANT. TECHNICAL REFERENCE: GR-1217-CORE, ISSUE 1, NOVEMBER 1995.
- 8 DATE CODE
- 9 PART NUMBER

RECOMMENDED PRINTED
CIRCUIT BOARD LAYOUT
COMPONENT SIDE OF PRINTED CIRCUIT BOARD

5120978-1

PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN B. CARBO 19SEP05	TE Connectivity			
DIMENSIONS: mm		CHK R. PATTERSON 19SEP05				
TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ± 1 PLC ±0.13 2 PLC ±0.050 3 PLC ±0.050 4 PLC ± ANGLES ±		APVD R. PATTERSON 19SEP05	NAME RECEPTACLE ASSEMBLY, 30 POSITION 6 ROW, DUAL BEAM, Z-PACK HS3			
MATERIAL 3 -		PRODUCT SPEC 108-1957	SIZE A200779		DRAWING NO C-5120978	RESTRICTED TO -
FINISH SOLDER TAIL: 2 - CONTACT: 1 -		APPLICATION SPEC 114-13020	SCALE 4:1		SHEET 1 OF 1	REV A1
		WEIGHT -	Customer Drawing			